



Product Change Notification / JAON-04FCXY806

Date:

20-Jul-2015

PCN Type:

Manufacturing Change

Notification Subject:

CCB 1491 Final Notice: Qualification of G700LTD molding compound and 8600 die attach epoxy for selected DFN, UDFN and DFN-S packages at NSEB site.

Notification Text:

PCN Status: Final notification

Microchip Parts Affected: See attachments of affected catalog part numbers (CPN) labeled as...PCN_JAON-04FCXY806_Affected_CPN.xlsPCN_JAON-04FCXY806_Affected_CPN.pdf

Description of Change: Qualification of G700LTD molding compound and 8600 die attach epoxy for 8L DFN (2x3x0.9mm), 8L DFN (3x3x0.9mm), 8L DFN (4x4x0.9mm), 10L DFN (3x3x0.9mm), 8L UDFN (2x3x0.5mm), 8L UDFN (3x3x0.5mm) and 8L DFN-S (6x5x0.9mm) packages at NSEB assembly site.

Pre Change: G770HCD molding compound and 8200T die attach epoxy

Post Change: G700LTD molding compound and 8600 die attach epoxy

Impacts to Data Sheet: None

Reason for Change: To improve manufacturability by qualifying molding compound and die attach material.

Change Implementation Status: In Progress

Estimated First Ship Date: February 28, 2015 (date code: 1509)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Markings to Distinguish Revised from Unrevised Devices: Traceability code

Revision History:**February 18, 2015:** Issued final notification.**July 20, 2015:** Revised PCN to remove some devices that will not be affected by this change. Revised the attached affected parts list.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

[PCN_JAON-04FCXY806_Qual Report.pdf](#)
[PCN_JAON-04FCXY806_Affected_CPN.pdf](#)
[PCN_JAON-04FCXY806_Affected_CPN.xls](#)

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